



OSV5XME1E1E

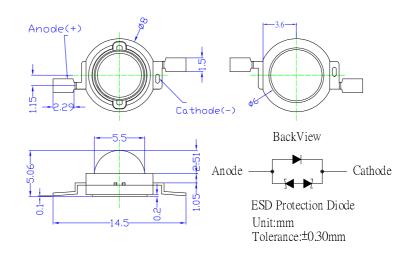
■Features

- · Highest Luminous Flux
- · Super Energy Efficiency
- · Long Lifetime Operation
- · Superior ESD protection
- · Superior UV Resistance

■Applications

- · Money Detector
- · UV-Curing
- · Sensor light
- · Photo-catalyst
- · Other Lighting

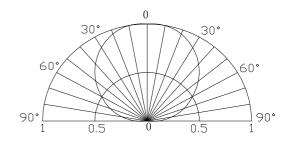
■Outline Dimension



■Absolute Maximum Rating

Item	Symbol	Value	Unit
DC Forward Current	I_F	400	mA
Pulse Forward Current#	I_{FP}	500	mA
Reverse Voltage	V_R	5	V
Power Dissipation	P _D	1600	mW
Operating Temperature	Topr	-30 ~ +85	$^{\circ}\mathbb{C}$
Storage Temperature	Tstg	-40~ +100	$^{\circ}\mathbb{C}$
Lead Soldering Temperature	Tsol	260°C/5sec	-

■Directivity



#Pulse width Max.10ms Duty ratio max 1/10

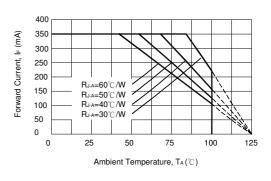
■Electrical -Optical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
DC Forward Voltage*	$V_{\rm F}$	I _F =350mA	3.0	3.3	4.0	V
DC Reverse Current	I_R	V _R =5V	-	-	10	μΑ
Peak Wavelength*	λ_{P}	I _F =350mA	400	405	410	nm
Radiant Power*	Ро	I _F =350mA	200	250	-	mW
50% Power Angle	2θ1/2	I _F =350mA	-	140	-	deg

^{*1} Tolerance of measurements of peak wavelength is ± 1 nm

Note: Don't drive at rated current more than 5s without heat sink for Xeon 3 emitter series.

■Forward Operating Current (DC)



LED & Application Technologies





(Ta=25°C)

(Ta=25℃)





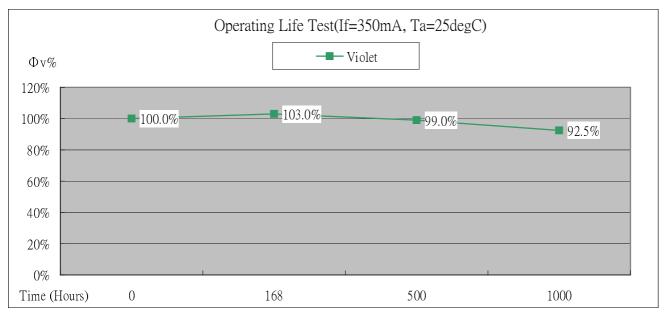


^{*2} Tolerance of measurements of radiant power is ±15%

^{*3} Tolerance of measurements of forward voltage is ±0.1V

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OPERATION LIFE TEST LUMINANCE RATE CURVE



^{*}Burn-in condition: 350mA White Heatsink.







^{*}Projection of Statistical Average Light Output Degradation Performance for LED Technology Extrapolated from OptoSupply QA Dept. Test Data.

^{*}According to OptoSupply outgoing Packaged Products Specification

^{*}MTBF:100,000hrs, 90% Confidence (A Failure is Any LED Which is Open, shorted or fails to Emit Light)

^{*}The Projected Data is Base on The Feature of LED Itself Under Normal Operation Conditions.

^{*}Any Improper Circuit Design or External Factors Might Cause a Different Result.



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■ Handling of Silicone Lens LEDs

Notes for handling of silicone lens LEDs

- Please do not use a force of over 3kgf impact or pressure on the silicone lens, otherwise it will cause a catastrophic failure.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- Avoid touching the silicone lens especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the silicone lens.
- Please store the LEDs away from dusty areas or seal the product against dust.
- When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the silicone lens must be prevented.
- Please do not mold over the silicone lens with another resin. (epoxy, urethane, etc)



